

July 2006

Single-Channel: 6N137, HCPL-2601, HCPL-2611 Dual-Channel: HCPL-2630, HCPL-2631 High Speed-10 MBit/s Logic Gate Optocouplers

Features

- Very high speed-10 MBit/s
- Superior CMR-10 kV/µs
- Double working voltage-480V
- Fan-out of 8 over -40°C to +85°C
- Logic gate output
- Strobable output
- Wired OR-open collector
- U.L. recognized (File # E90700)

Applications

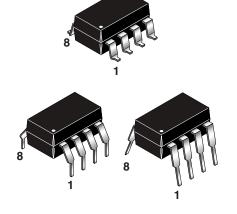
- Ground loop elimination
- LSTTL to TTL, LSTTL or 5-volt CMOS
- Line receiver, data transmission
- Data multiplexing
- Switching power supplies
- Pulse transformer replacement
- Computer-peripheral interface

Description

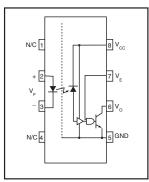
The 6N137, HCPL-2601/2611 single-channel and HCPL-2630/2631 dual-channel optocouplers consist of a 850 nm AlGaAS LED, optically coupled to a very high speed integrated photodetector logic gate with a strobable output. This output features an open collector, thereby permitting wired OR outputs. The coupled parameters are guaranteed over the temperature range of -40°C to +85°C. A maximum input signal of 5 mA will provide a minimum output sink current of 13mA (fan out of 8).

An internal noise shield provides superior common mode rejection of typically $10kV/\mu s$. The HCPL- 2601 and HCPL- 2631 has a minimum CMR of 5 kV/ μs . The HCPL-2611 has a minimum CMR of 10 kV/ μs .

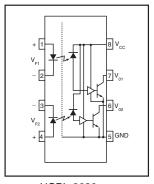
Package



Schematic



6N137 HCPL-2601 HCPL-2611



HCPL-2630 HCPL-2631

Truth Table (Positive Logic)

Input	Enable	Output
Н	Н	L
L	Н	Н
Н	L	Н
L	L	Н
Н	NC	L
L	NC	Н

A $0.1\mu F$ bypass capacitor must be connected between pins 8 and 5. (See note 1)

Absolute Maximum Ratings (T_A = 25°C unless otherwise specified)

Parameter		Symbol	Value	Units
Storage Temperature		T _{STG}	-55 to +125	°C
Operating Temperature		T _{OPR}	-40 to +85	°C
Lead Solder Temperature		T _{SOL}	260 for 10 sec	°C
EMITTER				
DC/Average Forward	Single Channel	I _F	50	mA
Input Current	Dual Channel (Each Channel)		30	
Enable Input Voltage Not to exceed V _{CC} by more than 500 mV	Single Channel	V _E	5.5	V
Reverse Input Voltage	Each Channel	V _R	5.0	V
Power Dissipation	Single Channel	P _I	100	mW
	Dual Channel (Each Channel)		45	
DETECTOR				
Supply Voltage		V _{CC} (1 minute max)	7.0	V
Output Current	Single Channel	I _O	50	mA
	Dual Channel (Each Channel)		50	
Output Voltage	Each Channel	Vo	7.0	V
Collector Output	Single Channel	Po	85	mW
Power Dissipation	Dual Channel (Each Channel)		60	

Recommended Operating Conditions

Parameter	Symbol	Min	Max	Units
Input Current, Low Level	I _{FL}	0	250	μA
Input Current, High Level	I _{FH}	*6.3	15	mA
Supply Voltage, Output	V _{CC}	4.5	5.5	V
Enable Voltage, Low Level	V _{EL}	0	0.8	V
Enable Voltage, High Level	V _{EH}	2.0	V _{CC}	V
Low Level Supply Current	T _A	-40	+85	°C
Fan Out (TTL load)	N		8	

^{*6.3}mA is a guard banded value which allows for at least 20% CTR degradation. Initial input current threshold value is 5.0 mA or less.

Electrical Characteristics (T_A = 0 to 70°C Unless otherwise specified) **Individual Component Characteristics**

Parameter		Test Conditions	Symbol	Min	Тур**	Max	Unit
EMITTER		(I _F = 10mA)	V _F			1.8	V
Input Forward Voltage		$T_A = 25^{\circ}C$			1.4	1.75	
Input Reverse Breakdown V	/oltage	$(I_{R} = 10 \mu A)$	B _{VR}	5.0			V
Input Capacitance		$(V_F = 0, f = 1 MHz)$	C _{IN}		60		pF
Input Diode Temperature Co	oefficient	$(I_F = 10mA)$	$\Delta V_F / \Delta T_A$		-1.4		mV/°C
DETECTOR							
High Level Supply Current	Single Channel	$(V_{CC} = 5.5 \text{ V}, I_F = 0 \text{ mA})$	I _{CCH}		7	10	mA
	Dual Channel	$(V_{E} = 0.5V)$			10	15	
Low Level Supply Current	Single Channel	$(V_{CC} = 5.5 \text{ V}, I_F = 10 \text{ mA})$	I _{CCL}		9	13	mA
	Dual Channel	$(V_{E} = 0.5V)$			14	21	
Low Level Enable Current		$(V_{CC} = 5.5 \text{ V}, V_{E} = 0.5 \text{V})$	I _{EL}		-0.8	-1.6	mA
High Level Enable Current	$(V_{CC} = 5.5 \text{ V}, V_{E} = 2.0 \text{V})$		I _{EH}		-0.6	-1.6	mA
High Level Enable Voltage	$(V_{CC} = 5.5 \text{ V}, I_F = 10 \text{ mA})$		V _{EH}	2.0			V
Low Level Enable Voltage	($V_{CC} = 5.5 \text{ V}, I_F = 10 \text{ mA})(\text{Note 3})$	V _{EL}			0.8	V

Switching Characteristics ($T_A = -40^{\circ}\text{C}$ to $+85^{\circ}\text{C}$, $V_{CC} = 5$ V, $I_F = 7.5$ mA Unless otherwise specified)

AC Characteristics	Test Conditions	Symbol	Min	Typ**	Max	Unit
Propagation Delay Time	(Note 4) $(T_A = 25^{\circ}C)$	T _{PLH}	20	45	75	ns
to Output High Level	$(R_L = 350\Omega, C_L = 15 \text{ pF}) \text{ (Fig. 12)}$				100	
Propagation Delay Time	(Note 5) (T _A = 25°C)	T _{PHL}	25	45	75	ns
to Output Low Level	$(R_L = 350\Omega, C_L = 15 \text{ pF}) \text{ (Fig. 12)}$				100	
Pulse Width Distortion	$(R_L = 350\Omega, C_L = 15 pF)$ (Fig. 12)	IT _{PHL} - T _{PLH} I		3	35	ns
Output Rise Time (10-90%)	$(R_L = 350\Omega, C_L = 15 pF)$ (Note 6) (Fig. 12)	t _r		50		ns
Output Rise Time (90-10%)	$(R_L = 350\Omega, C_L = 15 pF)$ (Note 7) (Fig. 12)	t _f		12		ns
Enable Propagation Delay Time to Output High Level	$(I_F = 7.5 \text{ mA}, V_{EH} = 3.5 \text{ V})$ $(R_L = 350\Omega, C_L = 15 \text{ pF}) \text{ (Note 8) (Fig. 13)}$	t _{ELH}		20		ns
Enable Propagation Delay Time to Output Low Level	$(I_F = 7.5 \text{ mA}, V_{EH} = 3.5 \text{ V})$ $(R_L = 350\Omega, C_L = 15 \text{ pF}) \text{ (Note 9) (Fig. 13)}$	t _{EHL}		20		ns
Common Mode Transient Immunity (at Output High	$(T_A = 25^{\circ}C) V_{CM} = 50V, (Peak)$ $(I_F = 0 \text{ mA}, V_{OH} (Min.) = 2.0V)$	ICM _H I				V/µs
Level)	6N137, HCPL-2630		5000	10,000 10,000		
	HCPL-2611 V _{CM} = 400V		10,000	15,000		
Common Mode Transient	$(R_L = 350\Omega) (I_F = 7.5 \text{ mA}, V_{OL} (Max.) = 0.8V)$	ICM _L I		10,000		V/µs
Immunity (at Output Low Level)	6N137, HCPL-2630 $ V_{CM} = 50V$ (Peak)					
20101)	HCPL-2601, HCPL-2631 (T _A = 25°C)(Note 11)(Fig. 14)		5000	10,000		
	HCPL-2611($T_A = 25^{\circ}C$) $ V_{CM} = 400V$		10,000	15,000		

Transfer Characteristics (T_A = -40 to +85°C Unless otherwise specified)

DC Characteristics	Test Conditions	Symbol	Min	Тур**	Max	Unit
High Level Output Current	$(V_{CC} = 5.5 \text{ V}, V_{O} = 5.5 \text{ V})$ $(I_{F} = 250 \mu\text{A}, V_{E} = 2.0 \text{ V}) \text{ (Note 2)}$				100	μΑ
Low Level Output Current	$(V_{CC} = 5.5 \text{ V}, I_F = 5 \text{ mA})$ $(V_E = 2.0 \text{ V}, I_{CL} = 13 \text{ mA}) \text{ (Note 2)}$.35	0.6	٧
Input Threshold Current	$(V_{CC} = 5.5 \text{ V}, V_O = 0.6 \text{ V}, V_E = 2.0 \text{ V}, I_{OL} = 13 \text{ mA})$			3	5	mA

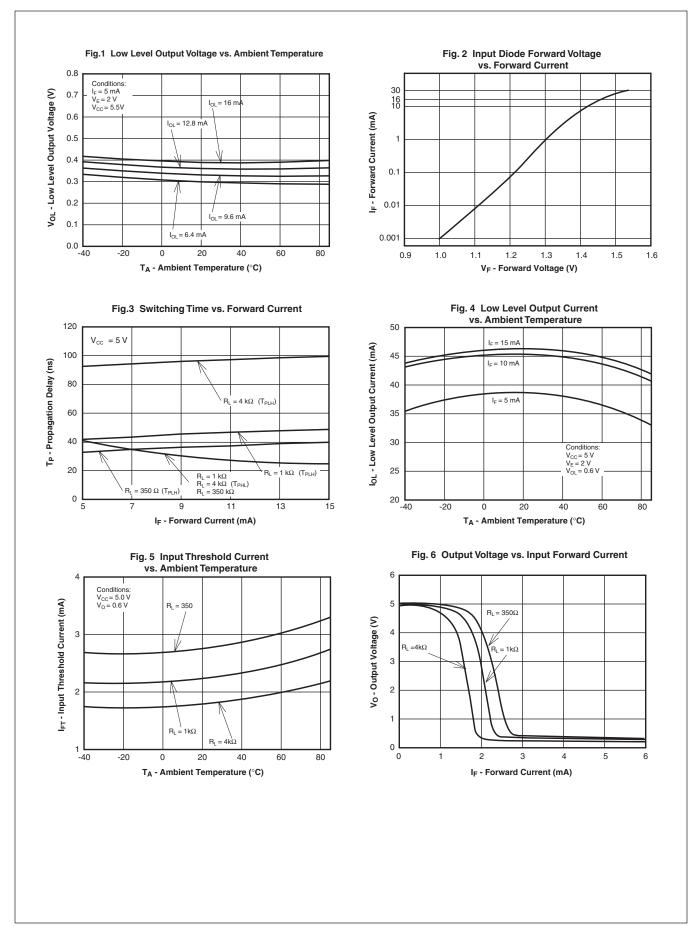
Isolation Characteristics ($T_A = -40$ °C to +85°C Unless otherwise specified.)

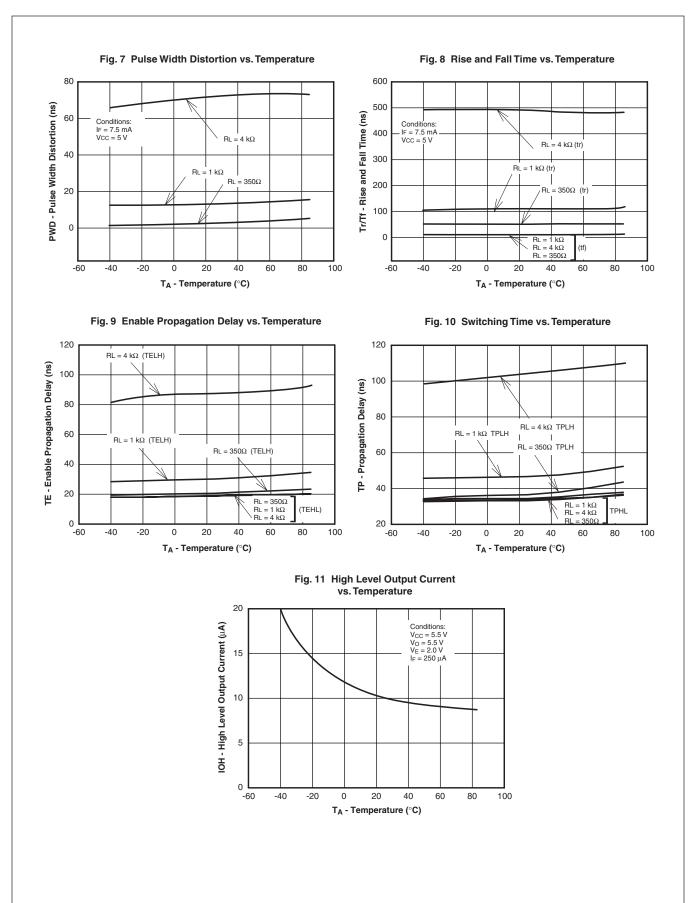
Characteristics	Test Conditions	Symbol	Min	Typ**	Max	Unit
Input-Output Insulation Leakage Current	(Relative humidity = 45%) $(T_A = 25^{\circ}C, t = 5 \text{ s})$ $(V_{I-O} = 3000 \text{ VDC})$ (Note 12)	I _{I-O}			1.0*	μА
Withstand Insulation Test Voltage	$(RH < 50\%, T_A = 25$ °C) $(I_{I-O} \le 2 \mu A)$ (Note 12) (t = 1 min.)	V _{ISO}	2500			V _{RMS}
Resistance (Input to Output)	(V _{I-O} = 500 V) (Note 12)	R _{I-O}		10 ¹²		Ω
Capacitance (Input to Output)	(f = 1 MHz) (Note 12)	C _{I-O}		0.6		pF

^{**} All Typicals at $V_{CC} = 5V$, $T_A = 25$ °C

NOTES

- The V_{CC} supply to each optoisolator must be bypassed by a 0.1μF capacitor or larger. This can be either a ceramic or solid tantalum capacitor with good high frequency characteristic and should be connected as close as possible to the package V_{CC} and GND pins of each device.
- 2. Each channel.
- 3. Enable Input No pull up resistor required as the device has an internal pull up resistor.
- t_{PLH} -Propagation delay is measured from the 3.75 mA level on the HIGH to LOW transition of the input current pulse to the 1.5 V level on the LOW to HIGH transition of the output voltage pulse.
- 5. t_{PHL} -Propagation delay is measured from the 3.75 mA level on the LOW to HIGH transition of the input current pulse to the 1.5 V level on the HIGH to LOW transition of the output voltage pulse.
- 6. t_r-Rise time is measured from the 90% to the 10% levels on the LOW to HIGH transition of the output pulse.
- 7. t_f-Fall time is measured from the 10% to the 90% levels on the HIGH to LOW transition of the output pulse.
- 8. t_{ELH} -Enable input propagation delay is measured from the 1.5 V level on the HIGH to LOW transition of the input voltage pulse to the 1.5 V level on the LOW to HIGH transition of the output voltage pulse.
- 9. t_{EHL} -Enable input propagation delay is measured from the 1.5 V level on the LOW to HIGH transition of the input voltage pulse to the 1.5 V level on the HIGH to LOW transition of the output voltage pulse.
- 10. CM_H-The maximum tolerable rate of rise of the common mode voltage to ensure the output will remain in the high state (i.e., V_{OUT} > 2.0 V). Measured in volts per microsecond (V/µs).
- 11. CM_L-The maximum tolerable rate of rise of the common mode voltage to ensure the output will remain in the low output state (i.e., V_{OUT} < 0.8 V). Measured in volts per microsecond (V/µs).</p>
- 12. Device considered a two-terminal device: Pins 1,2,3 and 4 shorted together, and Pins 5,6,7 and 8 shorted together.





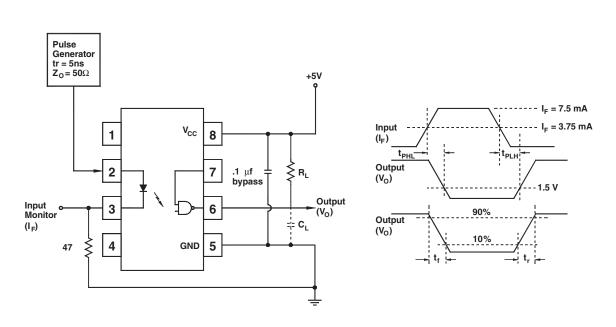


Fig. 12 Test Circuit and Waveforms for $t_{PLH},\,t_{PHL},\,t_{r}$ and t_{f} .

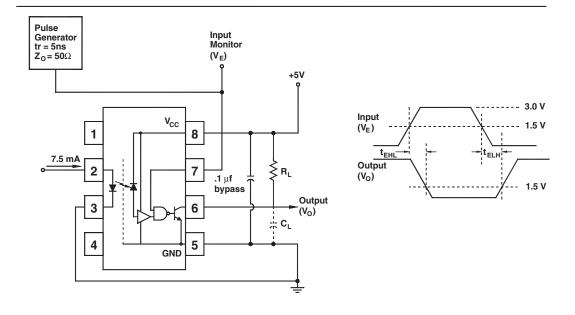


Fig. 13 Test Circuit t_{EHL} and t_{ELH} .

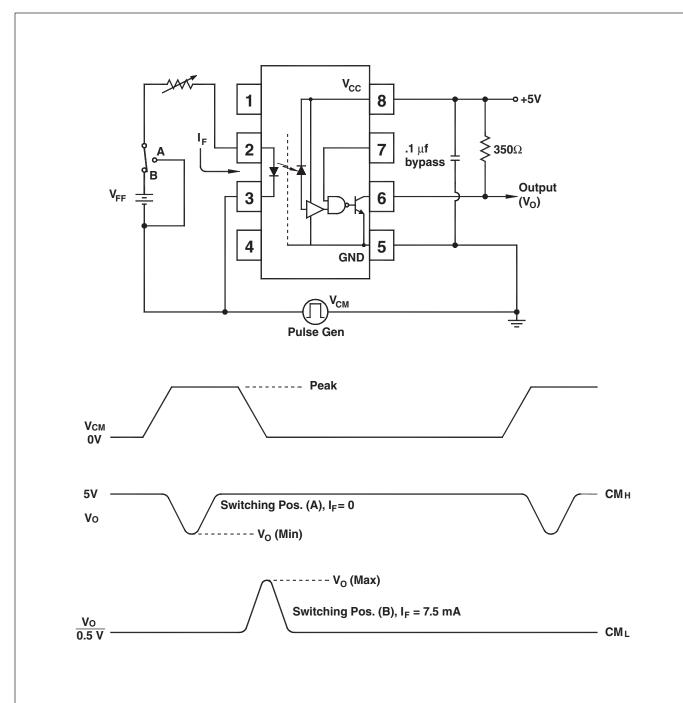
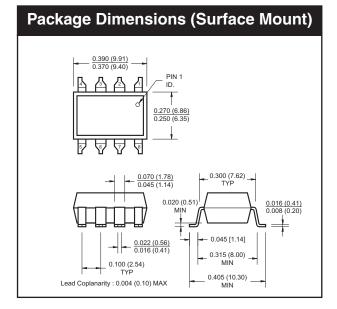
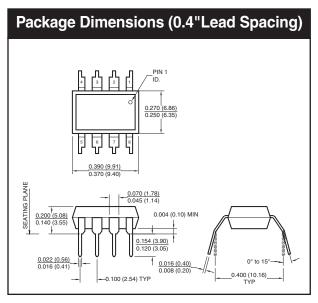
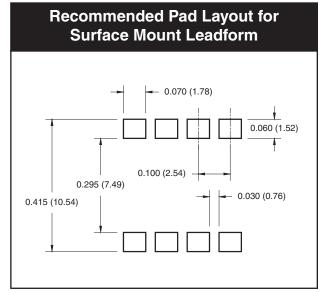


Fig. 14 Test Circuit Common Mode Transient Immunity

Package Dimensions (Through Hole) PIN 1 1D. 0.270 (6.86) 0.250 (6.35) 0.200 (5.09) 0.140 (3.55) 0.022 (0.56) 0.016 (0.41) 0.022 (0.56) 0.016 (0.41) 0.008 (0.20) 0.300 (7.62) TYP



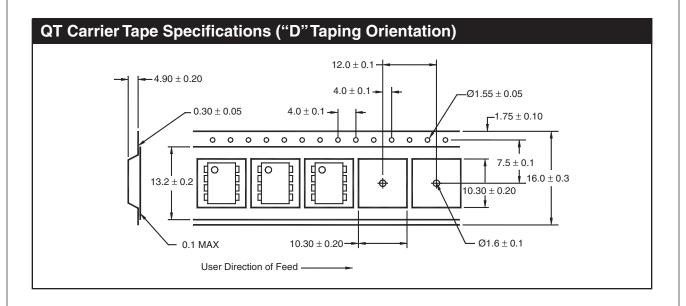




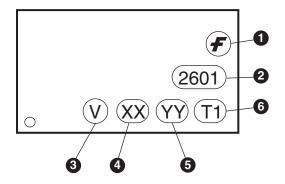
NOTEAll dimensions are in inches (millimeters)

Ordering Information

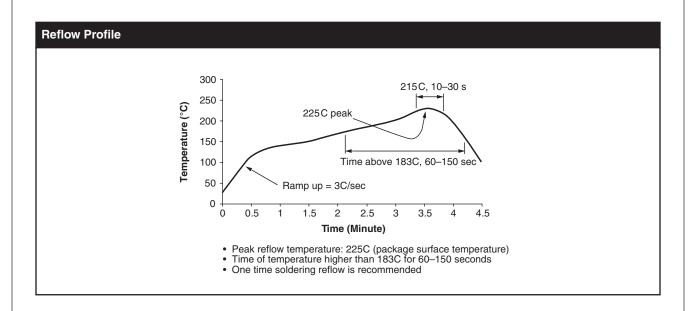
Option	Example Part Number	Description
S	6N137S	Surface Mount Lead Bend
SD	6N137SD	Surface Mount; Tape and reel
W	6N137W	0.4" Lead Spacing
V	6N137V	VDE0884
WV	6N137WV	VDE0884; 0.4" lead spacing
SV	6N137SV	VDE0884; surface mount
SDV	6N137SDV	VDE0884; surface mount; tape and reel



Marking Information



Definiti	Definitions					
1	Fairchild logo					
2	Device number					
3	VDE mark (Note: Only appears on parts ordered with VDE option – See order entry table)					
4	Two digit year code, e.g., '03'					
5	Two digit work week ranging from '01' to '53'					
6	Assembly package code					



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	MSXPro™	RapidConnect™	TINYOPTO™	
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The Power Franchise®		ScalarPump™	UHC™	
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- 2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

PRODUCT STATUS DEFINITIONS

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